



# Product Change Notification

**Change Notification #:** 117705 - 01  
**Change Title:** Select Intel® Optane™ Memory H10 with Solid State Storage, PCN 117705-01, Product Discontinuance, Order Code, **Order Coder Change, Reason for Revision: Correcting 3 Recommended Replacement SKUs and correcting key characteristics of the change**  
**Date of Publication:** September 17, 2020

## Key Characteristics of the Change:

Product Discontinuance, [Order Code](#)

## Forecasted Key Milestones:

<b>Last Product Discontinuance Order Date:</b>	August 31, 2020
<b>Last Product Discontinuance Shipment Date:</b>	September 30, 2020

## Description of Change to the Customer:

### **Reason for Revision: Correcting 3 Recommended Replacement SKUs and correcting key characteristics of the change**

Intel is announcing end of life **for existing order codes** for the Intel® Optane™ Memory H10 with Solid State Storage Series. **Intel is providing guidance and timeline for replacement SKUs.**

The **ordering codes** for Intel® Optane™ Memory H10 with Solid State Storage Series products listed on the "Products Affected/Intel Ordering Codes" table below will be discontinued and unavailable for additional orders after the "Last Product Discontinuance Order Date."

Effective September 30, 2020 Intel will stop shipping Intel® Optane™ Memory H10 with Solid State Storage hardware **with existing ordering codes.**

The recommended replacement SKUs are listed in the Products Affected Table.

## Customer Impact of Change and Recommended Action:

Please determine your remaining demand for the products listed in the "Products Affected/Intel Ordering Codes" table and place your "Last Product Discontinuance Order" in accordance with the "Key Milestones" listed above.

Intel will make commercially reasonable efforts to support last time order quantities.

The recommended replacement SKUs are noted within the affected products table within this PCN notice.

Please contact your local Intel Field Sales representative if you have any further questions about this End of Life notice [for existing order codes](#).

## Products Affected / Intel Ordering Codes:

Product Name	Product Code	Affected MM#	Recommended Replacement Product Code	Recommended Replacement MM#
Intel® Optane™ Memory H10 with Solid State Storage (16GB + 256GB, M.2 80mm PCIe 3.0, 3D XPoint™, QLC) Generic Single Pack	HBRPEKNX0101A01	984682	HBRPEKNX0101A08	999MJ9
Intel® Optane™ Memory H10 with Solid State Storage (32GB + 512GB, M.2 80mm PCIe 3.0, 3D XPoint™, QLC) Generic Single Pack	HBRPEKNX0202A01	984683	HBRPEKNX0202A08	999MJF
Intel® Optane™ Memory H10 with Solid State Storage (32GB + 1TB, M.2 80mm PCIe 3.0, 3D XPoint™, QLC) Generic Single Pack	HBRPEKNX0203A01	984684	HBRPEKNX0203A08	999MJG
Intel® Optane™ Memory H10 with Solid State Storage (16GB + 256GB, M.2 80mm PCIe 3.0, 3D XPoint™, QLC) Generic 100 Pack	HBRPEKNX0101A	999FD6	<a href="#">HBRPEKNX0101A06</a>	<a href="#">999MJH</a>
Intel® Optane™ Memory H10 with Solid State Storage (32GB + 512GB, M.2 80mm PCIe 3.0, 3D XPoint™, QLC) Generic 100 Pack	HBRPEKNX0202A	999FD8	<a href="#">HBRPEKNX0202A06</a>	<a href="#">999MJJ</a>
Intel® Optane™ Memory H10 with Solid State Storage (32GB + 1TB, M.2 80mm PCIe 3.0, 3D XPoint™, QLC) Generic 100 Pack	HBRPEKNX0203A	999FD9	<a href="#">HBRPEKNX0203A06</a>	<a href="#">999MJK</a>

## PCN Revision History:

Date of Revision:	Revision Number:	Reason:
August 3, 2020	00	Originally Published PCN
September 17, 2020	01	<a href="#">Correcting 3 Recommended Replacement SKUs and correcting key characteristics of the change</a>



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## 117705 - 01

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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